## THE UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATE OF EXPRESS MAILING I hereby certify that this paper and the documents and/or fees referred to as attached therein are being deposited with the United States Postal Service on November 20, 2003in an envelope as "Express Mail Post Office to Addressee" service under 37 CFR §1.10, Mailing Label Number EV 332826161 US, addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Ryan Eachus

Attorney Docket No.: ALTRP096/A1201

First Named Inventor: Wen-chou Vincent

Wang et al.

## UTILITY PATENT APPLICATION TRANSMITTAL (37 CFR. § 1.53(b))

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This is a request for filing a patent application under 37 CFR. § 1.53(b) in the name of inventors:

WEN-CHOU VINCENT WANG, DONALD S. FRITZ and YUAN LI

For: STRUCTURE AND MATERIAL FOR ASSEMBLING A LOW-K SI DIE TO ACHIEVE A LOW WARPAGE AND INDUSTRIAL GRADE RELIABILITY FLIP CHIP PACKAGE WITH **ORGANIC SUBSTRATE** 

**Application Elements:** 

22 Pages of Specification, Claims and Abstract (including cover sheet) 01 Sheet of formal Drawings 02 Pages executed Declaration

Accompanying Application Parts:

Assigned to: Altera Corporation

Do not publish this application. Nonpublication Request is attached. Assignment and Assignment Recordation Cover Sheet (recording fee of \$40.00 enclosed) 37 CFR 3.73(b) Statement by Assignee Information Disclosure Statement with Form PTO-1449 Copies of IDS Citations **Preliminary Amendment** Return Receipt Postcard

Other:

Claim For	Foreign Priority					
	is claimed unde  The certifi  The certifi  The certifi	ied copy is ed copy ha ed copy wi	. § 119. enclosed. s been filed in prior app	olication U.S. Ap	oplication	No.
Fee Calcu	lation (37 CFR § 1.	<u>16)</u>				
Ap	plicant is entitled to	Small Ent	ity Status under 37 C.F	.R. §1.27.		
	(Col. 1) Total Claims		(Col. 2) Claims	(Col. 3) Present Extra	Rate	Additional Fee
TOTAL	26	MINUS	20	6	x 18 =	108.00
INDEP.	3	MINUS	3	0	x 86 =	0
[] First presentation of multiple dependent claim \$280 =						
Basic Filing Fee under 37 C.F.R. §1.16(a) \$770 =						770.00
TOTAL						878.00
SMALL ENTITY 50% FILING FEE REDUCTION (if applicable)						
The C	commissioner is aut	horized to o	f \$ 918.00 is enclosed.  Charge any fees beyond  Deposit Account No.	the amount encl 500388 (Order N	osed which	ch may be RP096).
General A	uthorization for Pet	ition for Ex	stension of Time (37 CI	FR §1.136)		
Appli for any sub	cants hereby make a	and general ne Commis	ly authorize any Petitio sioner is also authorize unt No. 500388 (Order	ons for Extension  d to charge any e	extension	e as may be needed fees under 37 CFR
Neas	se send corresponde	nce to the f	following address:			
Customer Number 022434						
Date: Nov	rember 20, 2003		Desmund Gean Registration No. 52	d Llean 2,937		

Page 2

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Wen-chou Vincent Wang et

Attorney Docket No.: ALTRP096/A1201

Application No.: Please assign

Examiner: Please assign

Group: Please assign

Filed: Herewith

Title: STRUCTURE AND MATERIAL FOR ASSEMBLING A LOW-K SI DIE TO ACHIEVE A LOW WARPAGE AND INDUSTRIAL GRADE RELIABILITY FLIP CHIP PACKAGE

WITH ORGANIC SUBSTRATE

CERTIFICATE OF EXPRESS MAILING

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## NONPUBLICATION REQUEST AND CERTIFICATION (35 U.S.C. 122(b)(2)(B)(i))

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen (18) months after filing. I hereby request that the attached application NOT be published under 35 U.S.C. 122(b).

Date: Nov. 20, 2003

Desmund Gean

Registration No. 52,937

NOTE:

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications, eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign of international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).